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REVISION HISTORY

12/2016—Rev. B to Rev. C

Changes to Figure 27	12
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10/2013—Rev. A to Rev. B

Changes to Features Section	1
Changes to Table Summary Statement and Table 1	3
Changes to Table 2	5
Changes to Gains Greater than 14 Section and Figure 30	13
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2/2013—Rev. 0 to Rev. A

Change to Features	1
Changes to Figure 3 and Table 3	5
Change to Ordering Guide	15
Added Automotive Products Section	15

10/2009—Revision 0: Initial Version

SPECIFICATIONS

$T_{OPR} = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ for AD8209WBRM grade, $T_{OPR} = -40^{\circ}\text{C}$ to $+150^{\circ}\text{C}$ for AD8209WHRM grade, $T_A = 25^{\circ}\text{C}$, $V_S = 5\text{ V}$, $R_L = 25\text{ k}\Omega$ (R_L is the output load resistor), unless otherwise noted.

Table 1.

Parameter	Test Conditions ¹	Min	Typ	Max	Unit
SYSTEM GAIN					
Initial			14		V/V
Error vs. Temperature					
AD8209WBRM	$0.075\text{ V} \leq V_{OUT} \leq (V_S - 0.1\text{ V})$, dc, T_{OPR}			± 0.3	%
AD8209WHRM	$0.100\text{ V} \leq V_{OUT} \leq (V_S - 0.12\text{ V})$, dc, T_{OPR}			± 0.3	%
Gain Drift	T_{OPR}	0		-20	ppm/ $^{\circ}\text{C}$
VOLTAGE OFFSET					
Initial Input Offset (Referred to Input [RTI])	$V_{CM} = 0.15\text{ V}$, T_A			± 2	mV
Input Offset (RTI) Over Temperature	$V_{CM} = 0\text{ V}$, T_{OPR}			± 4	mV
Voltage Offset vs. Temperature	$V_{CM} = 0\text{ V}$, T_{OPR}	-20		+20	$\mu\text{V}/^{\circ}\text{C}$
INPUT					
Input Impedance					
Differential		360	400	440	k Ω
Common Mode		180	200	220	k Ω
V_{CM} (Continuous)		-2		+45	V
CMRR ²	$V_{CM} = -2\text{ V}$ to $+45\text{ V}$, dc $f = \text{dc}$ to 10 kHz , ³ T_{OPR}	80	100		dB
		80			dB
PREAMPLIFIER (A1)					
Gain			7		V/V
Gain Error					
AD8209WBRM	$0.0375\text{ V} \leq V_{OUT} \leq (V_S - 0.1\text{ V})$, dc, T_{OPR}	-0.3		+0.3	%
AD8209WHRM	$0.050\text{ V} \leq V_{OUT} \leq (V_S - 0.1\text{ V})$, dc, T_{OPR}	-0.3		+0.3	%
Output Voltage Range	AD8209WBRM	0.0375		$V_S - 0.1$	V
	AD8209WHRM	0.05		$V_S - 0.1$	V
Output Resistance		97	100	103	k Ω
OUTPUT BUFFER (A2)					
Gain			2		V/V
Gain Error					
AD8209WBRM	$0.075\text{ V} \leq V_{OUT} \leq (V_S - 0.1\text{ V})$, dc, T_{OPR}	-0.3		+0.3	%
AD8209WHRM	$0.1\text{ V} \leq V_{OUT} \leq (V_S - 0.12\text{ V})$, dc, T_{OPR}	-0.3		+0.3	%
Output Voltage Range ^{4, 5}	$R_L = 25\text{ k}\Omega$, differential Input (V) = 0 V, T_{OPR} Pin 3 (A1 output) driving Pin 4 (A2 input)				
AD8209WBRM		0.075		$V_S - 0.1$	V
AD8209WHRM		0.1		$V_S - 0.12$	V
Output Voltage Range ⁶	Pin 4 (A2 input) driven with external source				
AD8209WBRM		0.075		$V_S - 0.1$	V
AD8209WHRM		0.1		$V_S - 0.12$	V
Input Bias Current	T_{OPR}			50	nA
Output Resistance	$R_L = 1\text{ k}\Omega$, frequency = dc		2		Ω
DYNAMIC RESPONSE					
System Bandwidth	$V_{IN} = 0.01\text{ V p-p}$, $V_{OUT} = 0.14\text{ V p-p}$		80		kHz
Slew Rate	$V_{IN} = 0.28\text{ V}$, $V_{OUT} = 4\text{ V step}$		1		V/ μs
NOISE					
0.1 Hz to 10 Hz			20		$\mu\text{V p-p}$
Spectral Density, 1 kHz (RTI)			500		nV/ $\sqrt{\text{Hz}}$

Parameter	Test Conditions ¹	Min	Typ	Max	Unit
POWER SUPPLY					
Operating Range		4.5		5.5	V
Quiescent Current	Typical, T _A		1.6		mA
Quiescent Current vs. Temperature	V _{OUT} = 0.1 V dc, V _S = 5 V, T _{OPR}			2.7	mA
AD8209WBRM				3.0	mA
AD8209WHRM					
PSRR	V _S = 4.5 V to 5.5 V, T _{OPR}	66	80		dB
TEMPERATURE RANGE	For Specified Performance at T _{OPR}				
AD8209WBRM		−40		+125	°C
AD8209WHRM		−40		+150	°C

¹ V_{CM} = input common-mode voltage.

² Source imbalance < 2 Ω.

³ The AD8209 preamplifier exceeds 80 dB CMRR at 10 kHz. However, because the output is available only by way of the 100 kΩ resistor, even a small amount of pin-to-pin capacitance between the IN pins and the A1 and A2 pins might couple an input common-mode signal larger than the greatly attenuated preamplifier output. The effect of pin-to-pin coupling can be neglected in all applications by using a filter capacitor from Pin 3 to GND.

⁴ The output voltage range of the AD8209 varies depending on the load resistance and temperature. For additional information on this specification, refer to Figure 12 and Figure 13.

⁵ The output voltage range of A2 assumes that Pin 3 (A1 output) and Pin 4 (A2 input) are shorted together. A 25 kΩ load resistor is used for testing.

⁶ The output voltage range of A2 assumes Pin 4 (A2 input) is driven with an external voltage source. A 25 kΩ load resistor is used for testing.

ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter	Rating
Supply Voltage	12 V
Continuous Input Voltage (Common Mode)	–24 V to +80 V
Differential Input Voltage	±12 V
Reversed Supply Voltage Protection	0.3 V
ESD Human Body Model for Shunt-Based Applications ¹	±8000 V
Operating Temperature Range	
AD8209WBRM	–40°C to +125°C
AD8209WHRM	–40°C to +150°C
Storage Temperature Range	–65°C to +150°C
Output Short-Circuit Duration	Indefinite
Lead Temperature Range (Soldering 10 sec)	300°C

¹ Shunt-based applications have a low impedance shunt resistor between +IN and –IN. See Figure 24 for an example of a shunt-based application.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

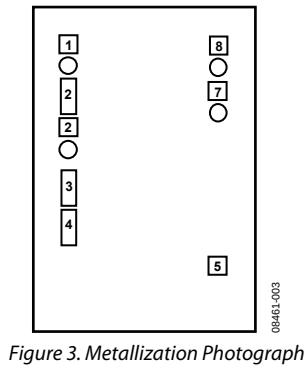
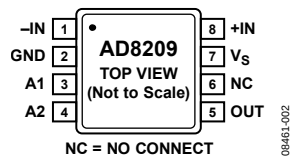


Table 3. Pin Function Descriptions

Pin No.	Mnemonic	Coordinates		Description
		X	Y	
1	–IN	–322	+563	Inverting Input
2	GND	–321	+208	Ground
2	GND	–327	+339	Ground
3	A1	–321	–51	Preamplifier (A1) Output
4	A2	–321	–214	Buffer (A2) Input
5	OUT	+321	–388	Buffer (A2) Output
6	NC			No Connect
7	V _s	+322	+363	Supply
8	+IN	+322	+561	Noninverting Input

TYPICAL PERFORMANCE CHARACTERISTICS

$T_{OPR} = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, $T_A = 25^{\circ}\text{C}$, $V_S = 5\text{ V}$, $R_L = 25\text{ k}\Omega$ (R_L is the output load resistor), unless otherwise noted.

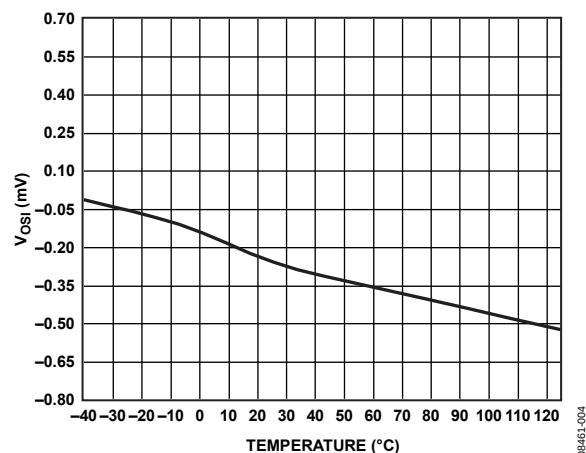


Figure 4. Typical Offset Drift vs. Temperature

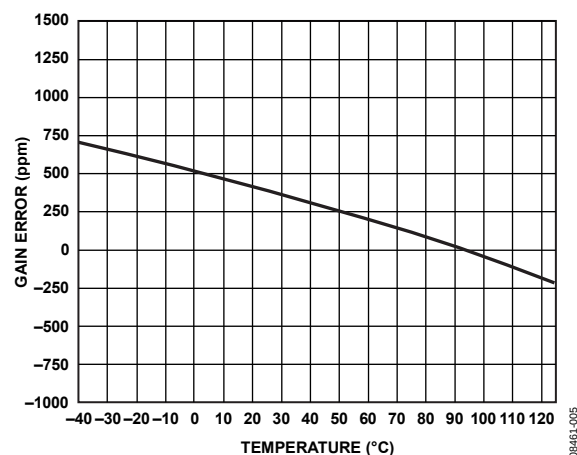


Figure 7. Typical Gain Error vs. Temperature

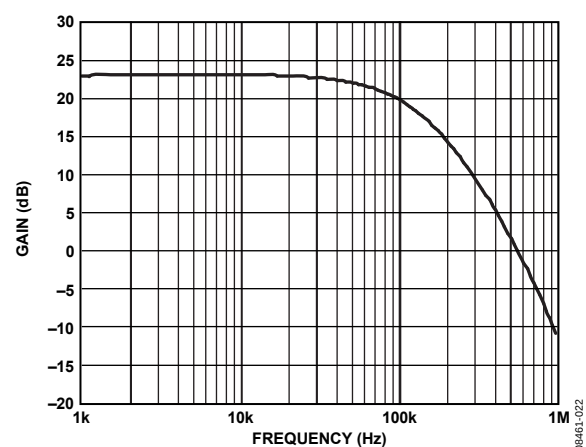


Figure 5. Typical Small-Signal Bandwidth

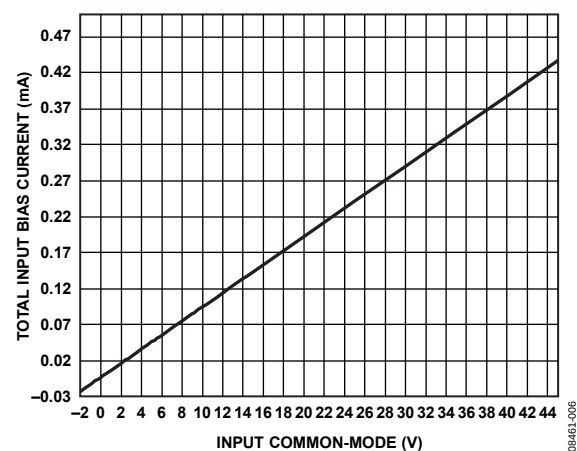


Figure 8. Total Input Bias Current vs. Common-Mode Voltage, with +IN and -IN Pins Connected (Shorted)

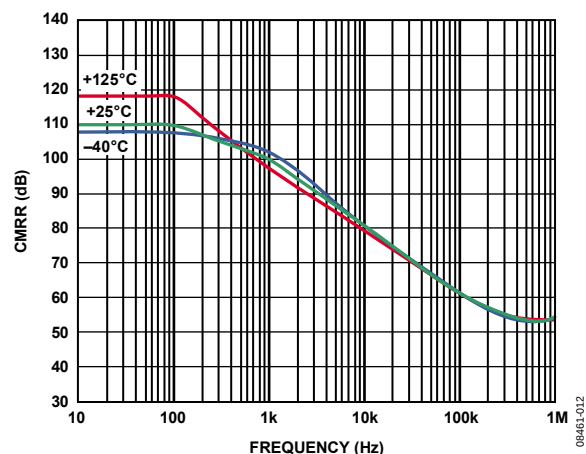


Figure 6. Typical CMRR vs. Frequency

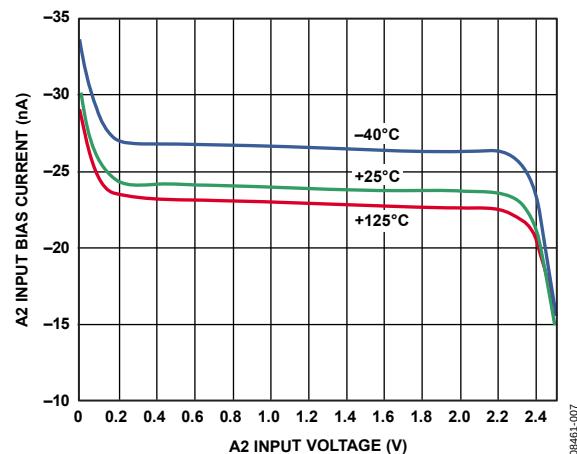


Figure 9. Input Bias Current of A2 vs. Input Voltage and Temperature

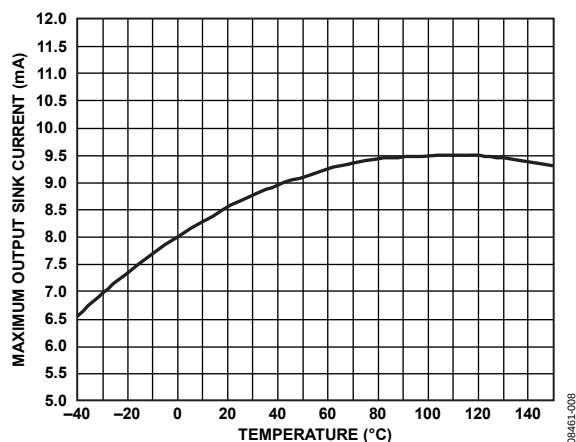


Figure 10. Maximum Output Sink Current vs. Temperature

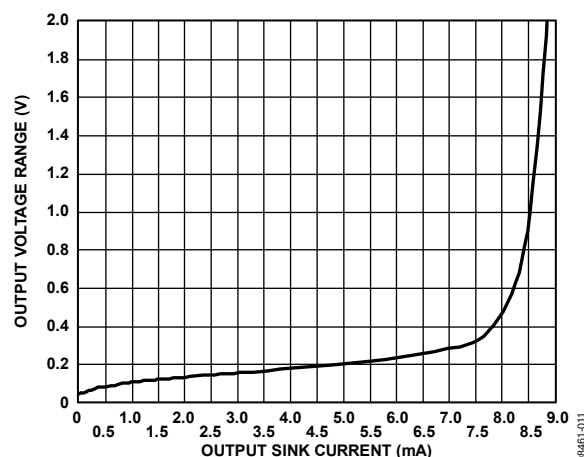


Figure 13. Output Voltage Range from GND vs. Output Sink Current

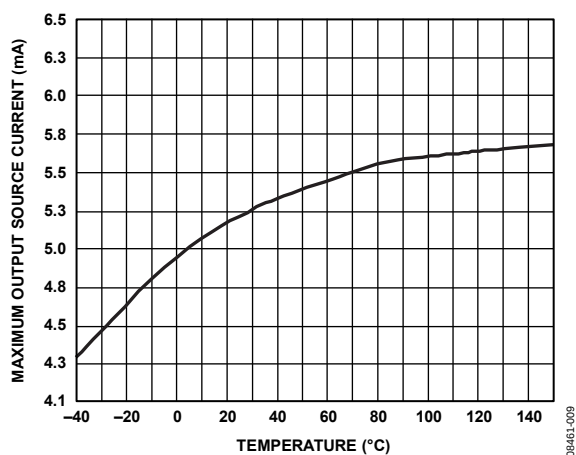


Figure 11. Maximum Output Source Current vs. Temperature

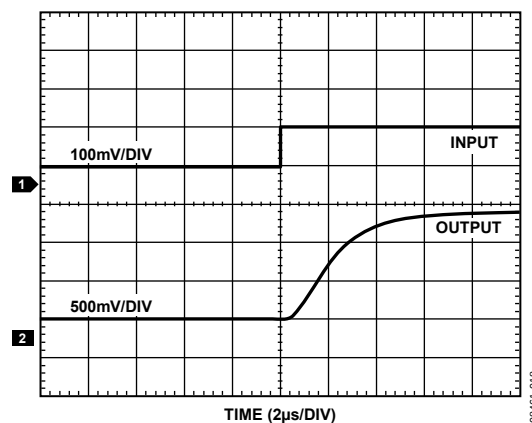


Figure 14. Rise Time

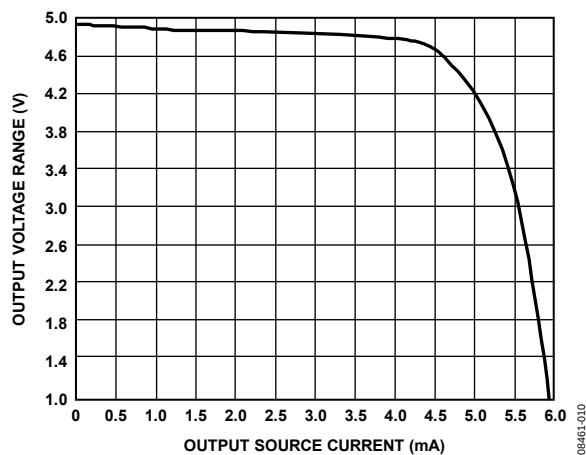


Figure 12. Output Voltage Range of A2 vs. Output Source Current

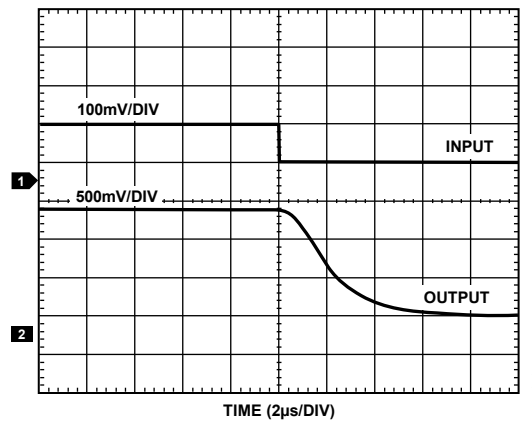


Figure 15. Fall Time

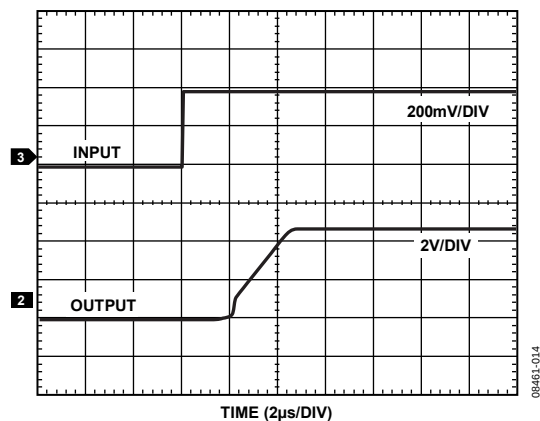


Figure 16. Differential Overload Recovery, Rising

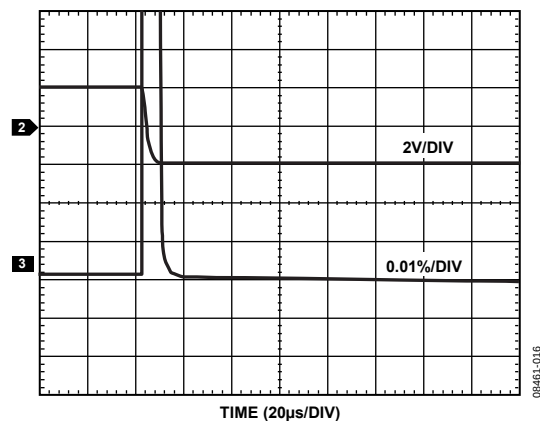


Figure 19. Settling Time, Falling

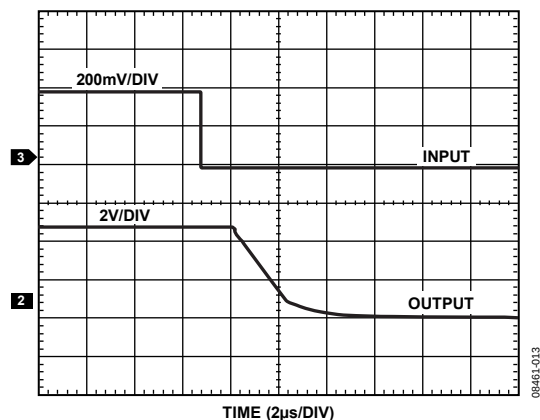


Figure 17. Differential Overload Recovery, Falling

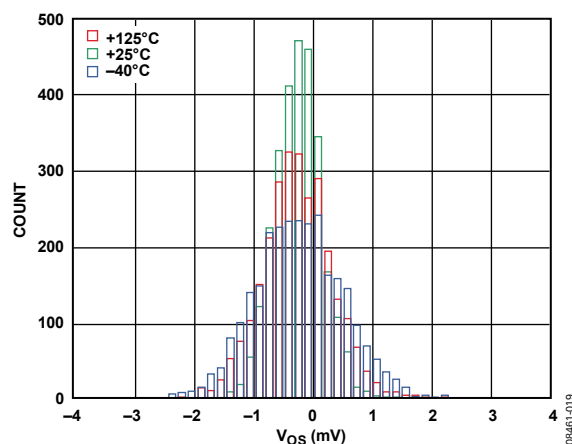


Figure 20. Offset Distribution

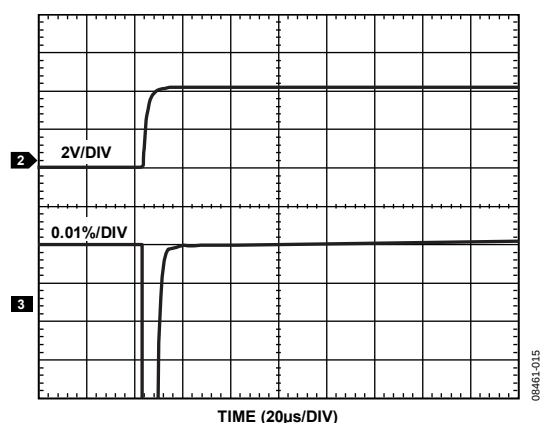


Figure 18. Settling Time, Rising

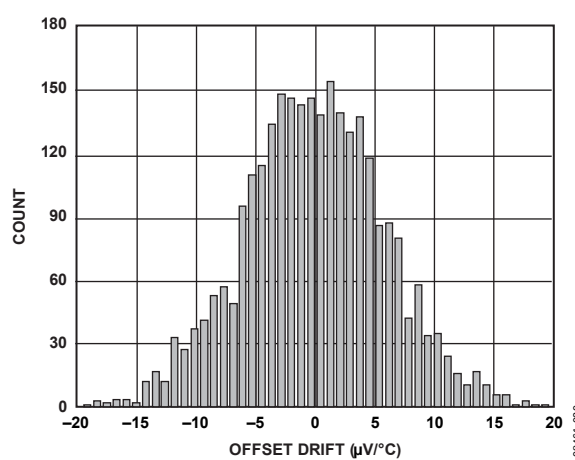


Figure 21. Offset Drift Distribution

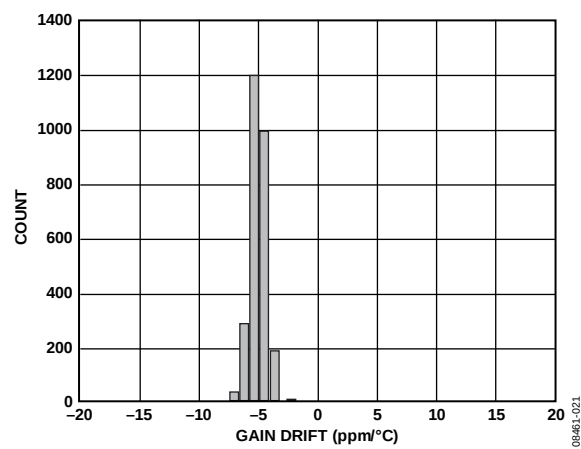


Figure 22. Gain Drift Distribution

APPLICATIONS INFORMATION

HIGH-SIDE CURRENT SENSING WITH A LOW-SIDE SWITCH

In load control configurations for high-side current sensing with a low-side switch, the PWM-controlled switch is ground referenced. An inductive load (solenoid) connects to a power supply/battery. A resistive shunt is placed between the switch and the load (see Figure 24). An advantage of placing the shunt on the high side is that the entire current, including the recirculation current, is monitored because the shunt remains in the loop when the switch is off. In addition, shorts to ground can be detected with the shunt on the high side, enhancing the diagnostics of the control loop. In this circuit configuration, when the switch is closed, the common-mode voltage moves down to near the negative rail. When the switch is opened, the voltage reversal across the inductive load causes the common-mode voltage to be held one diode drop above the battery by the clamp diode.

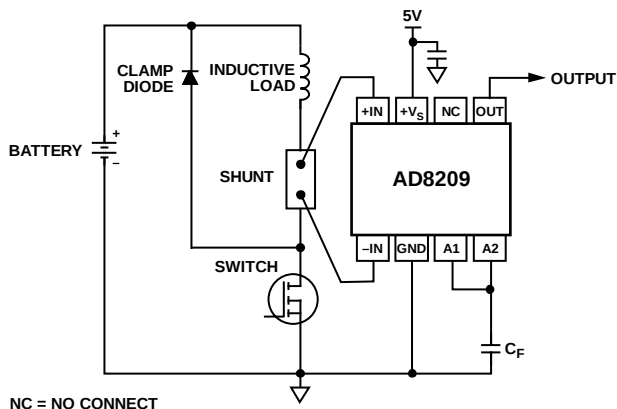


Figure 24. Low-Side Switch

In cases where a high-side switch is used for PWM control of the load current in an application, the AD8209 can be used as shown in Figure 25. The recirculation current through the freewheeling diode (clamp diode) is monitored through the shunt resistor. In this configuration, the common-mode voltage in the application drops below GND when the FET is switched off. The AD8209 operates down to -2 V, providing an accurate current measurement.

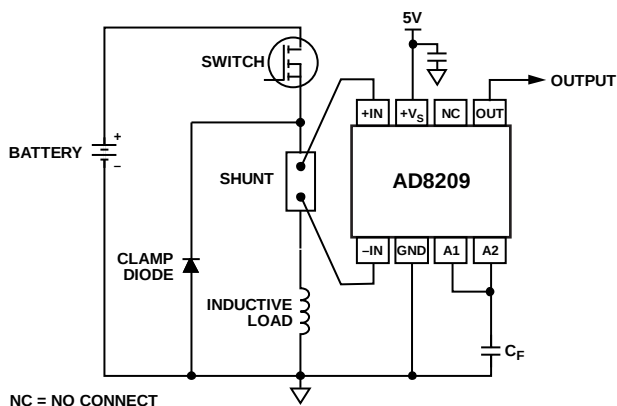


Figure 25. High-Side Switch

HIGH-RAIL CURRENT SENSING

In the high-rail current-sensing configuration, the shunt resistor is referenced to the battery. High voltage is present at the inputs of the current-sense amplifier. When the shunt is battery referenced, the AD8209 produces a linear ground-referenced analog output. Additionally, the AD8214 can be used to provide an overcurrent detection signal in as little as 100 ns (see Figure 26). This feature is useful in high current systems where fast shutdown in overcurrent conditions is essential.

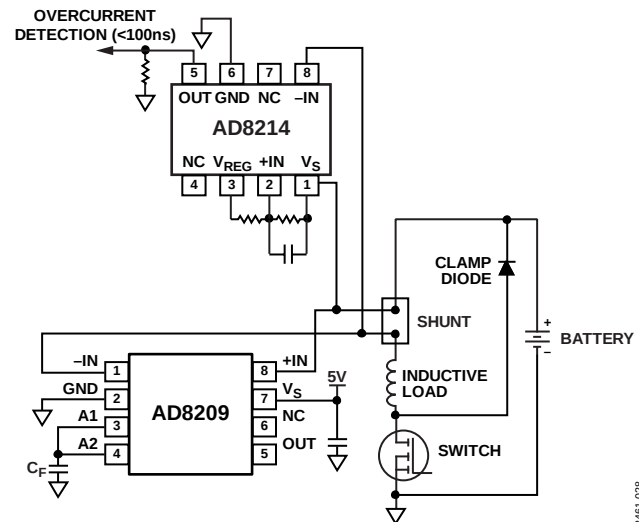


Figure 26. Battery-Referenced Shunt Resistor

LOW-SIDE CURRENT SENSING

In systems where low-side current sensing is preferable, the AD8209 provides a simple, high accuracy, integrated solution. In this configuration, the AD8209 rejects ground noise and offers high input to output linearity, regardless of the differential input voltage.

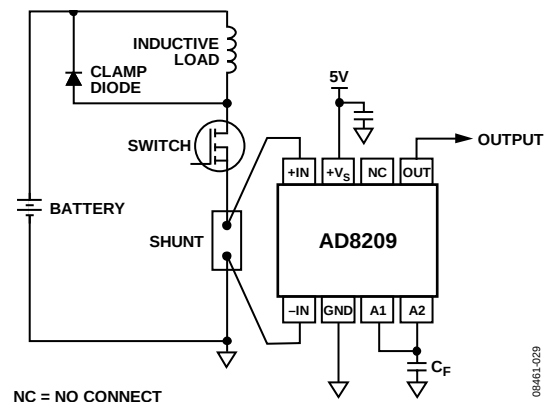


Figure 27. Ground-Referenced Shunt Resistor

4 mA to 20 mA Current Loop Receiver

The AD8209 can also be used in low current-sensing applications, such as the 4 mA to 20 mA current loop receiver shown in Figure 28. In such applications, the relatively large shunt resistor may degrade the common-mode rejection. Adding a resistor of equal value on the low impedance side of the input corrects this error.

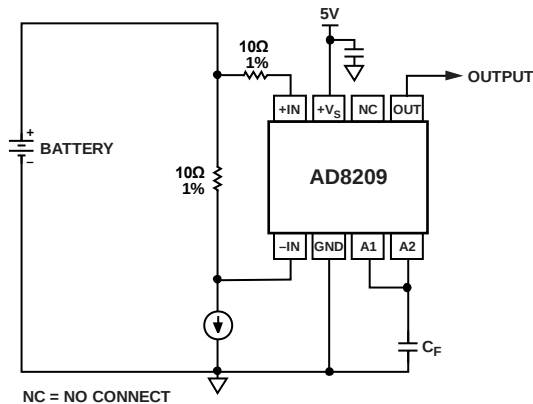


Figure 28. 4 mA to 20 mA Current Loop Receiver

GAIN ADJUSTMENT

The default gain of the preamplifier and buffer are 7 V/V and 2 V/V, respectively, resulting in a composite gain of 14 V/V. With the addition of external resistor(s) or trimmer(s), the gain can be lowered, raised, or finely calibrated.

Gains Less than 14

Because the preamplifier has an output resistance of 100 kΩ, an external resistor connected from Pin 3 and Pin 4 to GND decreases the gain by the following factor (see Figure 29):

$$R_{EXT}/(100\text{ k}\Omega + R_{EXT})$$

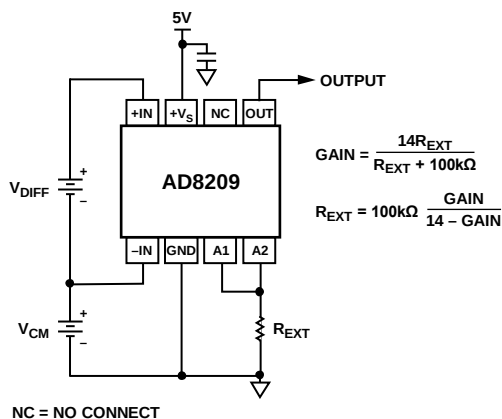


Figure 29. Adjusting for Gains Less than 14

The overall bandwidth is unaffected by changes in gain by using this method, although there may be a small offset voltage due to the imbalance in source resistances at the input to the buffer. In many cases, this can be ignored, but if desired, the offset voltage can be nulled by inserting a resistor in series with Pin 4. The resistor used should be equal to 100 kΩ minus the parallel sum of R_{EXT} and 100 kΩ. For example, with $R_{EXT} = 100\text{ k}\Omega$ (yielding a composite gain of 7 V/V), the optional offset nulling resistor is 50 kΩ.

Gains Greater than 14

Connecting a resistor from the output of the buffer amplifier to its noninverting input, as shown in Figure 30, increases the gain. The gain is now multiplied by the factor

$$R_{EXT}/(R_{EXT} - 100\text{ k}\Omega)$$

For example, it is doubled for $R_{EXT} = 200\text{ k}\Omega$. Overall gains as high as 50 are achievable in this way. Note that the accuracy of the gain becomes critically dependent on the resistor value at high gains. In addition, the effective input offset voltage at Pin 1 and Pin 8 (which is about six times the actual offset of A1) limits the use of the part in high gain, dc-coupled applications.

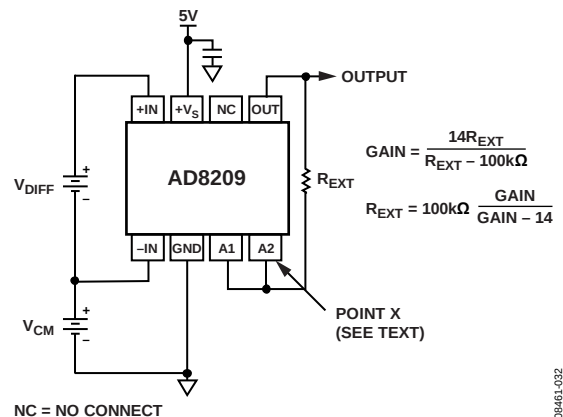


Figure 30. Adjusting for Gains Greater than 14

A small offset voltage arises from an imbalance in source resistances and the finite bias currents inherently present at the input of A2. In most applications, this additional offset error is comparable to the specified offset range and therefore introduces negligible skew. However, it can be essentially eliminated by the addition of a resistor in series with the parallel combination of R_{EXT} and 100 kΩ (at point X in Figure 30) so the total resistance is maintained at 100 kΩ. For example, at a gain of 20, when $R_{EXT} = 332\text{ k}\Omega$ and the parallel combination of R_{EXT} and 100 kΩ is 77 kΩ, the series resistor placed at point X is 23 kΩ.

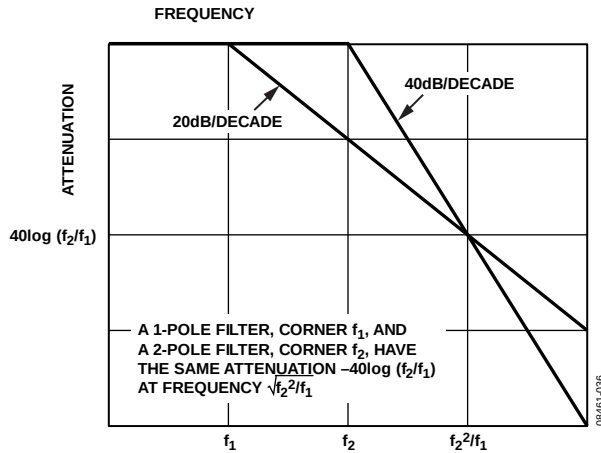


Figure 34. Comparative Responses of Single-Pole and Two-Pole Low-Pass Filters

HIGH LINE CURRENT SENSING WITH LPF AND GAIN ADJUSTMENT

The circuit shown in Figure 35 is similar to Figure 24, but includes gain adjustment and low-pass filtering.

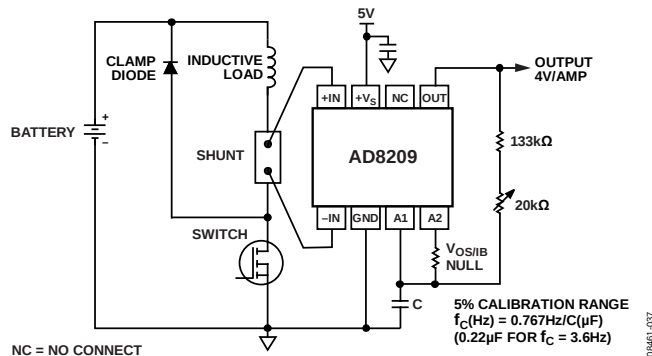


Figure 35. High Line Current-Sensor Interface; Gain = 40 V/V, Single-Pole, Low-Pass Filter

A power device that is either on or off controls the current in the load. The average current is proportional to the duty cycle of the input pulse and is sensed by a small-value resistor. The average differential voltage across the shunt is typically 100 mV, although its peak value is higher by an amount that depends on the inductance of the load and the control frequency. The common-mode voltage, on the other hand, extends from roughly 1 V above ground for the on condition to about 1.5 V above the battery voltage in the off condition. The conduction of the clamping

diode regulates the common-mode potential applied to the device. For example, a battery spike of 20 V may result in an applied common-mode potential of 21.5 V to the input of the devices.

To produce a full-scale output of 4 V, a gain of 40 V/V is used, adjustable by $\pm 5\%$ to absorb the tolerance in the shunt. There is sufficient headroom to allow 10% overrange (to 4.4 V). The roughly triangular voltage across the sense resistor is averaged by a single-pole, low-pass filter that is set with a corner frequency of 3.6 Hz, which provides about 30 dB of attenuation at 100 Hz. A higher rate of attenuation can be obtained by using a two-pole filter with a corner frequency of 20 Hz, as shown in Figure 36. Although this circuit uses two separate capacitors, the total capacitance is less than half of what is needed for the single-pole filter.

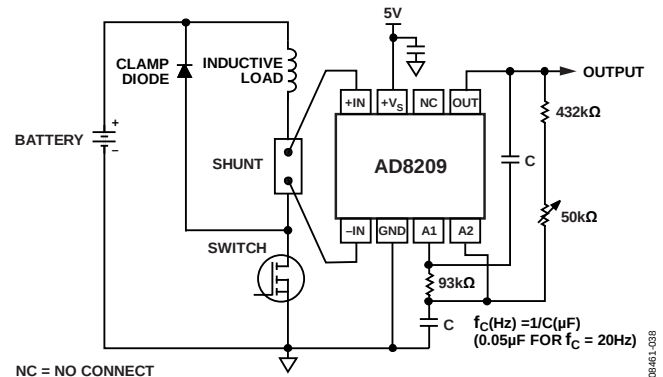


Figure 36. Two-Pole Low-Pass Filter

OUTLINE DIMENSIONS

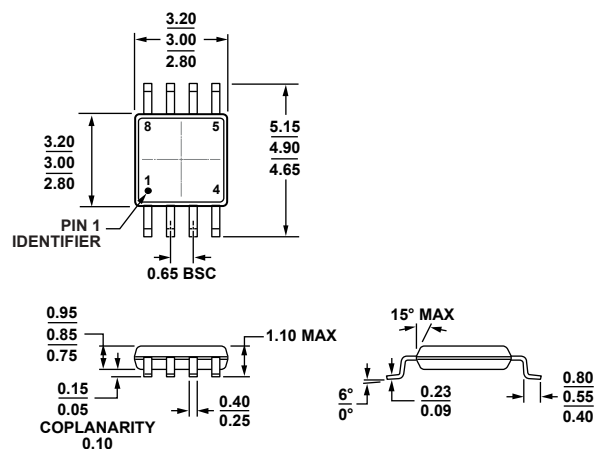


Figure 37. 8-Lead Mini Small Outline Package [MSOP]
(RM-8)

Dimensions shown in millimeters

ORDERING GUIDE

Model ^{1, 2}	Temperature Package	Package Description	Package Option	Branding
AD8209WBRMZ	−40°C to +125°C	8-Lead Mini Small Outline Package (MSOP)	RM-8	Y26
AD8209WBRMZ-R7	−40°C to +125°C	8-Lead Mini Small Outline Package (MSOP)	RM-8	Y26
AD8209WBRMZ-RL	−40°C to +125°C	8-Lead Mini Small Outline Package (MSOP)	RM-8	Y26
AD8209WHRMZ	−40°C to +150°C	8-Lead Mini Small Outline Package (MSOP)	RM-8	Y51
AD8209WHRMZ-RL	−40°C to +150°C	8-Lead Mini Small Outline Package (MSOP)	RM-8	Y51

¹ Z = RoHS Compliant Part.

² W = Qualified for Automotive Applications.

AUTOMOTIVE PRODUCTS

The [AD8209W](#) models are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that these automotive models may have specifications that differ from the commercial models; therefore, designers should review the Specifications section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.